

WIDE BAND GAP semiconductors for power electronics applications

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10th June - 2022

WHERE
TECHNOLOGY
IS AN ATTITUDE

01

Introduction

02

New WBG semiconductors

- GaN
- SiC

03

Experiences developed at Ikerlan

- GaN-based designs
- SiC-based designs

04

Conclusions

Private not-for-profit Technological Research Centre

“OUR FINAL GOAL IS TO TRANSFER
TECHNOLOGY TO OUR
INDUSTRIAL CLIENTS”



ikerlan

MEMBER OF BASQUE RESEARCH & TECHNOLOGY ALLIANCE



OVER
364
PEOPLE

READY FOR PRESENT AND
FUTURE TECHNOLOGICAL
CHALLENGES



25,4 M€
TOTAL INCOME FOR 2021

12,4 M€ TRANSFERS TO COMPANIES
12,3 M€ IN RESEARCH
PROJECTS IN 2021
(DFG, GV, AGE and H2020)
0,7 M€ OTHER
INCOME



Sectors

32% TRANSPORT AND
MOBILITY
26% MANUFACTURING
17% ENERGY
14% SERVICES AND
OTHER INDUSTRIES
9% AUTOMOTIVE
1% HEALTH
1% AERONAUTICS

1. BASQUE COUNTRY



2. SANTANDER

3. OVIEDO

4. GIRONA

5. BARCELONA

6. VALENCIA

7. SEVILLE

8. SANTIAGO DE COMPOSTELA

9. PARIS

10. BESANÇON

11. GRENOBLE

12. LEUVEN

13. BRUSSELS

14. EDINBURGH

15. AACHEN

16. SIEGEN

17. ZURICH

18. VIENNA

19. LULEÅ

20. AALBORG

21. OLDENBURG

22. USA



“WE COLLABORATE WITH LEADING
TECHNOLOGICAL CENTERS AND
UNIVERSITIES IN A GLOBAL SCOPE”

H2020 (2021-2024)

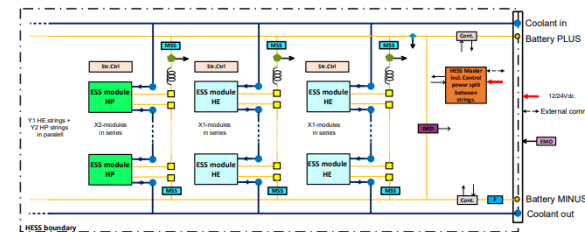


- **WP4 (component development):** Design and develop the components for a modular and flexible hybrid battery system towards low cost.
- Design: BMS, DC/DC converter, cooling system, control units, mechanical housing, system protections, etc.
- Currently: early stage of design.
- WP4 Milestone: **May 2023**, all components built.
- Modular topology: **12 modules connected in series to a 1kV DC bus**
- Only two strings in the prototype: **155A/string**
- **Each module:** DC/DC converter of 100V-155A
 - GaN: very high current, a lot of devices in parallel → very expensive
 - SiC: very low voltage → not appropriate
 - Si: lower cost, good enough performance → best balanced option

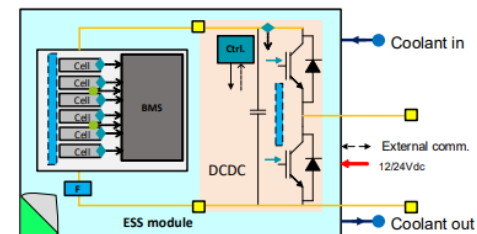


This project has received funding from the European Union's Horizon 2020 research and innovation programme under grant agreement No 963560.

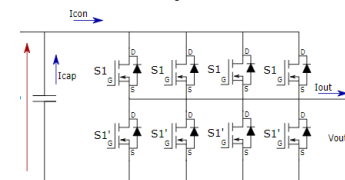
HESS system:



Each module:



Each DC/DC converter:



Si MOSFET 200V



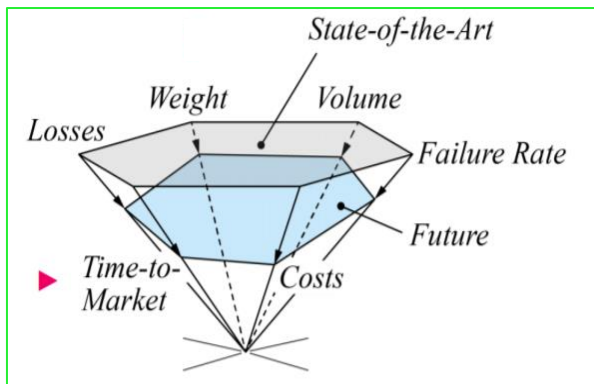
- Low conduction resistance
- Availability
- Cheap

www.seabat-h2020.eu

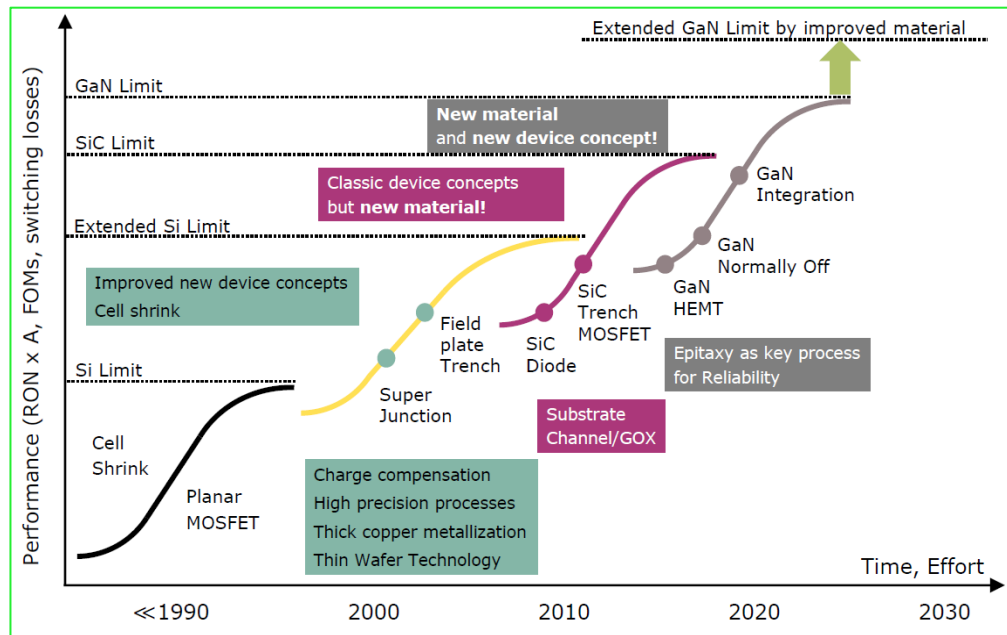


02. New WBG semiconductors

CONVERTERS OBJECTIVE



SEMICONDUCTORS EVOLUTION

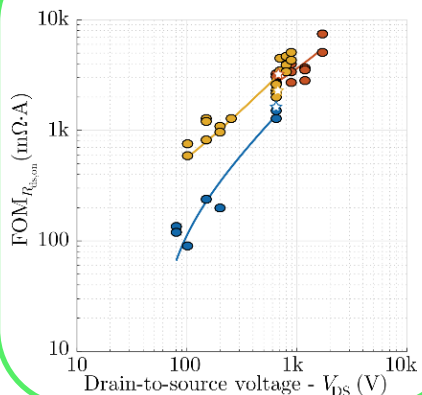


* Sources: O. Häberlen, Technical Challenges to Safeguard the Gallium Nitride Roadmap, Ultimate GaN Kick-off meeting, May 14, 2019

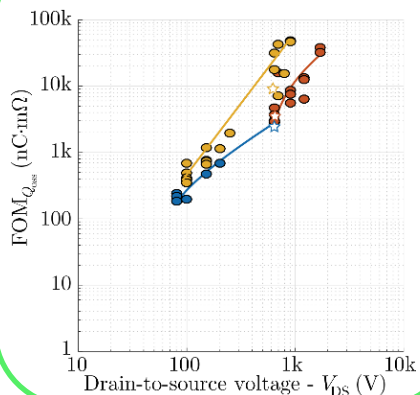
COMPARISON OF DIFFERENT SEMICONDUCTORS MAIN FEATURES



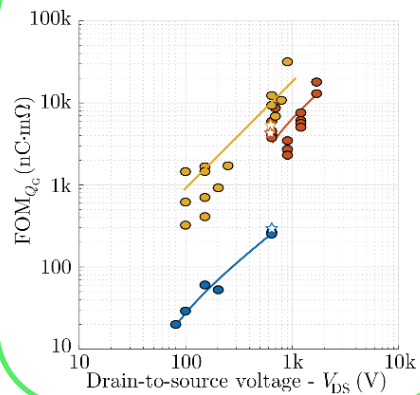
Conduction resistance



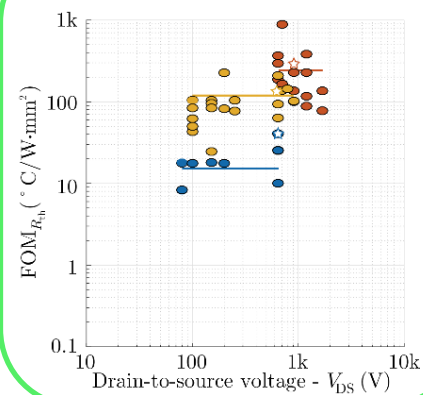
Output charge



Gate charge



Thermal charact.

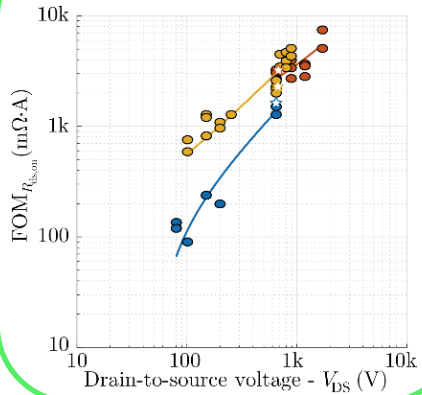


ADVANTAGES WITH RESPECT TO Si

GaN	SiC
Operating voltage < 650 V	Operating voltage > 600 V
Low conduction losses	Similar losses in conduction



Conduction resistance

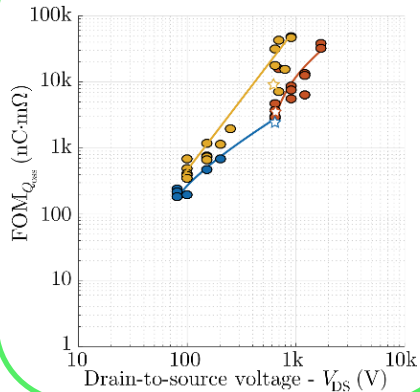


ADVANTAGES WITH RESPECT TO Si

GaN	SiC
Operating voltage < 650 V	Operating voltage > 600 V
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Fewer switching losses	Fewer switching losses
It has hardly any reverse coating charges because it is bi-directional	SiC diode has no reverse coating charges



Output charge

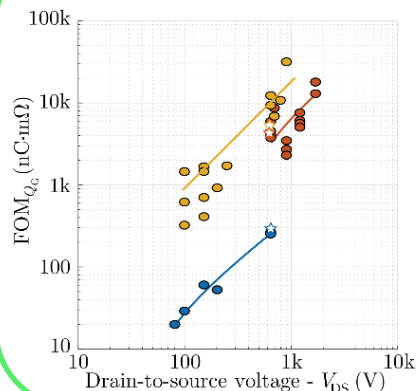


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Requires very low gate driver charges	Requires lower gate charges



Gate charge

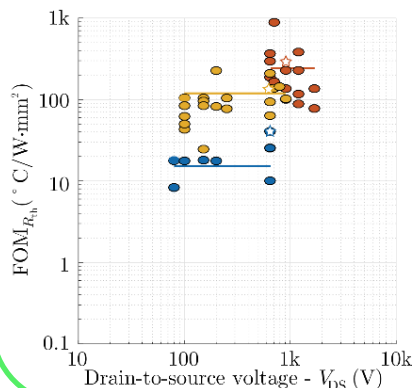


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Low conduction losses	Similar losses in conduction
Fewer switching losses	Fewer switching losses
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Requires very low ignition power	Lower ignition charges
	High thermal cooling capacity



Thermal charact.

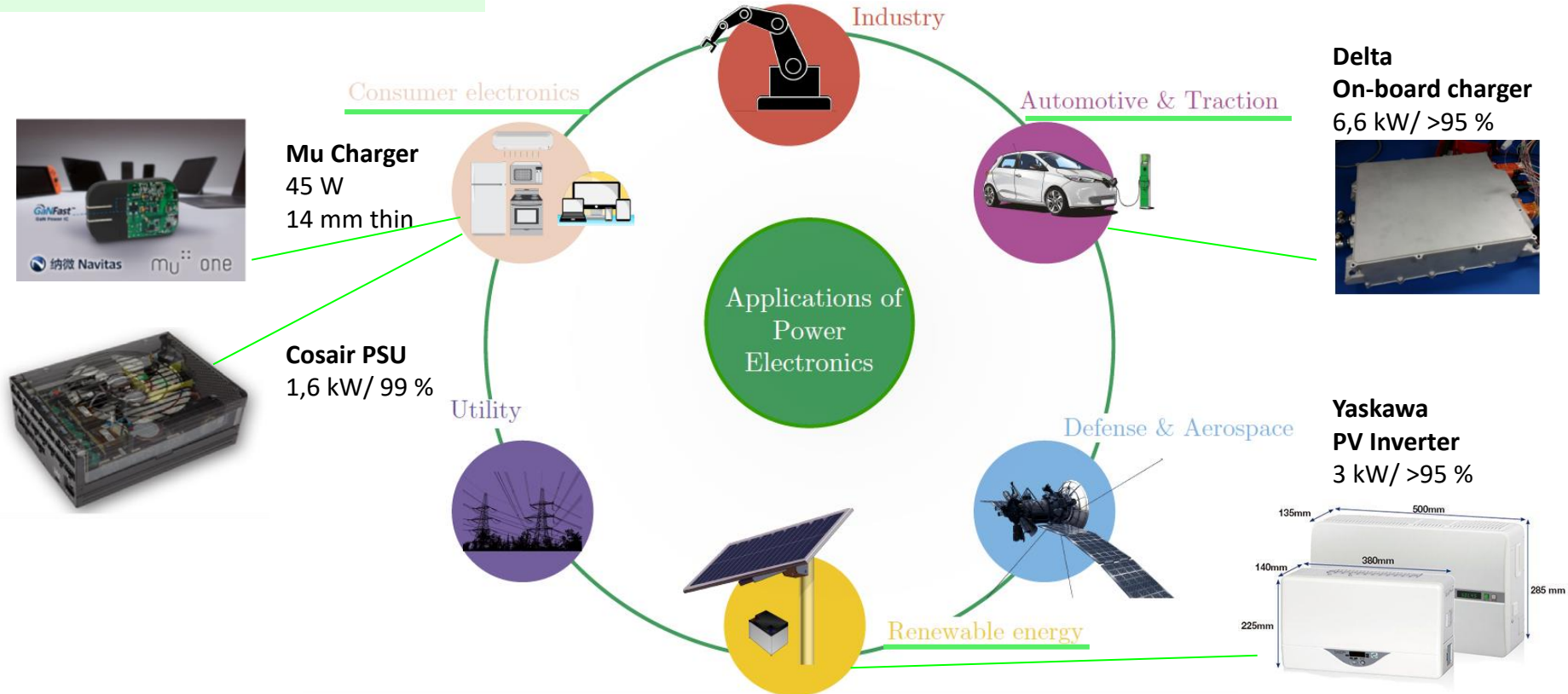


Allows switching at high frequencies with similar losses!

DISADVANTAGES WITH RESPECT TO THE Si

GaN	SiC
Low gate driver voltage- danger of causing false on stages	
Even if it is bidirectional, it has a poor quality diode due to its structure – it is necessary to minimize dead-times to avoid unwanted losses	The SiC-MOSFET has a poor quality intrinsic diode – it is quite common to put an extra antiparallel SiC diode to minimize losses
Less thermal cooling capacity – as the chip is so small, it has very small dissipation area	
Very high switching speed (dv/dt and di/dt) – EMI, degradation insulations, degradation bearings...	
Lack of reliability data - immature technology at application level	In theory better reliability - still to be proven
Cost (x5 relative to a Si-MOSFET 650V-40A). Expectations of a considerable price reduction when dedicated production will be launched for GaN.	Cost (x3 discrete – x10 modules > 1200 V). Downward trend, but will not reach Si prices in the future.

POTENTIAL GaN APPLICATIONS



New WBG semiconductors

POTENTIAL SiC APPLICATIONS



Ingeteam
Single-phase inverter
2,5 – 6 kW TLM SERIES



General Electric
2,5 MW
solar inverter



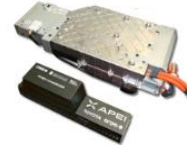
Delta
11 kW
solar inverter



Mitsubishi
Automotive inverter



Hitachi
Automotive inverter



Embedded charger



Mitsubishi
SiC inverter
in e-machine



Toyota
SiC inverter



General Electric
75 kW starter inverter



Kinki Roetgen
Source 500 W for X-Ray generator



Mitsubishi
Traction inverter



ABB
Traction battery charger



Hitachi
Traction inverter



CAF P&A
Traction inverter



IKS Co
100 kV/240 A
Pulse generator



Fuji Electric
Industrial inverter



IKS Co
5 kW/10 kW industrial
induction



General Electric
1 MW substation



03.

Experiences developed at Ikerlan

GaN

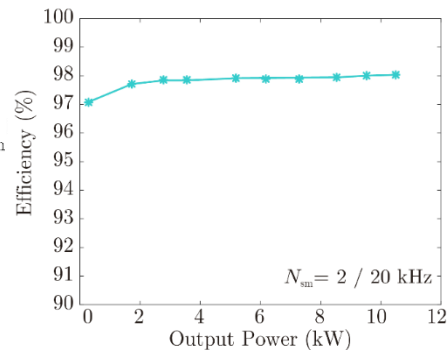
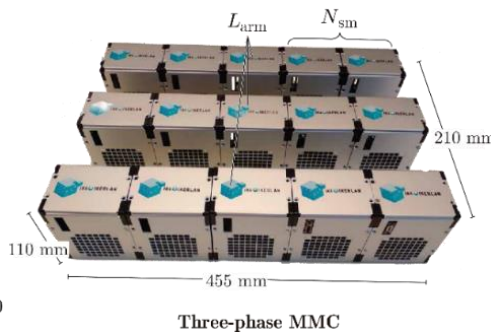
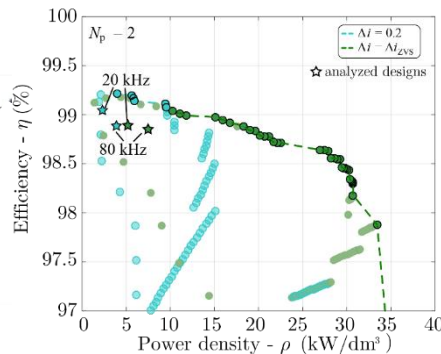
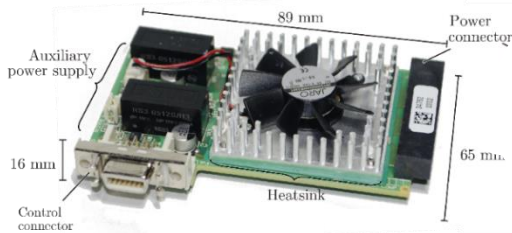
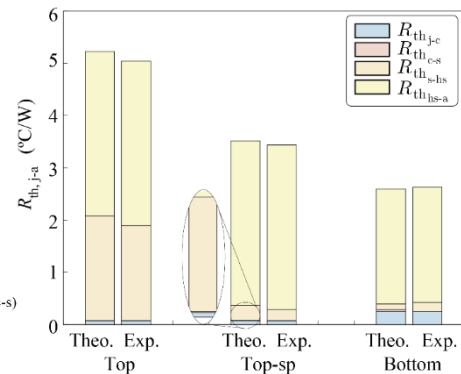
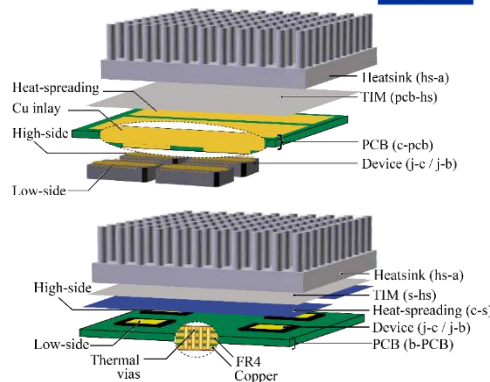
ECSEL/H2020 (2015-2018)



- Evaluating different cooling solutions (Top, Bot)
- 4 kW buck converter and MMC converter
- Soft-switching and hard-switching analysis.
- Single switch and parallel study.
- Efficiencies >99 % at 80 kHz CCM (<10 kW/l).
- Efficiencies >98 % at 300 kHz to DCM (<30 kW/l).



This project has received funding from the European Union's Horizon 2020 research and innovation programme under grant agreement No 662133.



www.powerbase-project.eu



This project has received funding from the European Union's Horizon 2020 research and innovation programme under grant agreement No 770019.

GaN

H2020 (2017-2021)



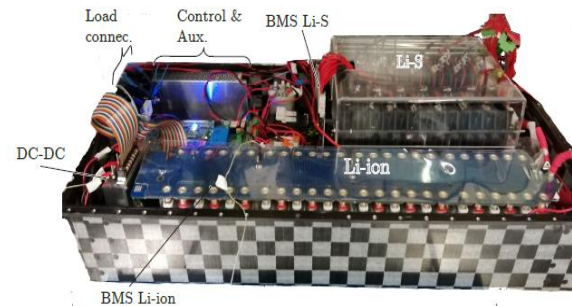
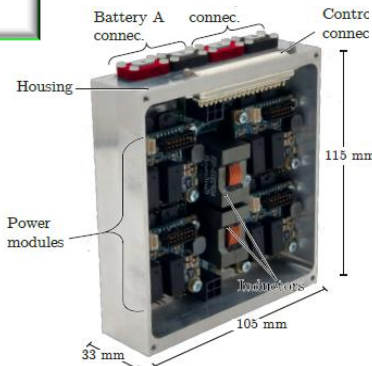
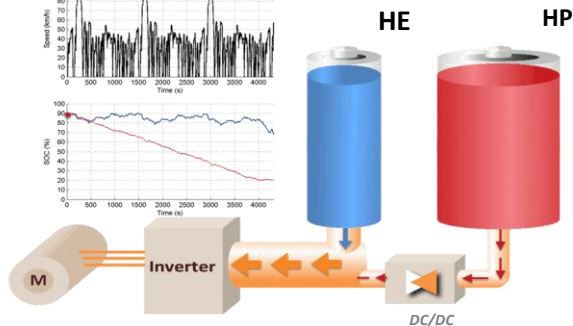
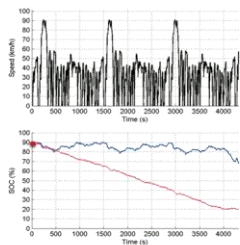
- DC-DC converter for hybridization of High Power and High Energy EV batteries.
- 48 V/ 240 W converter.
- Integrated, compact and low weight solution
- Dual Battery system based on Li-ion, Li-S and GaN-based DC-DC:
 - Nominal energy of **1972.9 Wh**
 - **101.90 Wh.kg-1** → **+31.99%** with respect to single Li-ion
 - **13.31 Wh.L-1** → **+8.41%** with respect to single Li-ion

Si-based solution

Semiconductors	Passives	Const.	Losses
35.2W	0.9W	7W	5W
Σ 43.1 W			
Cooling sys.	Passives	Const.	Volume
91 cm ³	44.5 cm ³	56 cm ³	50 cm ³
Σ 191.5 cm ³			
Cooling sys.	Passives	Const.	Weight
245.6 gr	94 gr	96 gr	88 gr
Σ 435.6 gr			

GaN-based solution

Const.	Passives	Semiconductors	Losses
5W	0.9W	19W	3W
Σ 24.9 W			
Const.	Passives	Cooling sys.	Volume
50 cm ³	44.5 cm ³	11.8 cm ³	50 cm ³
Σ 106.3 cm ³			
Const.	Passives	Cooling sys.	Weight
88 gr	94 gr	31.8 gr	88 gr
Σ 213.8 gr			



www.h2020-ghost.eu



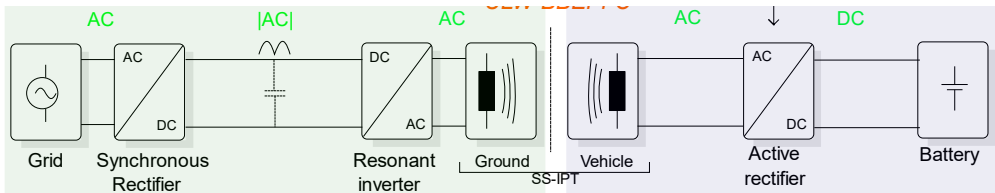
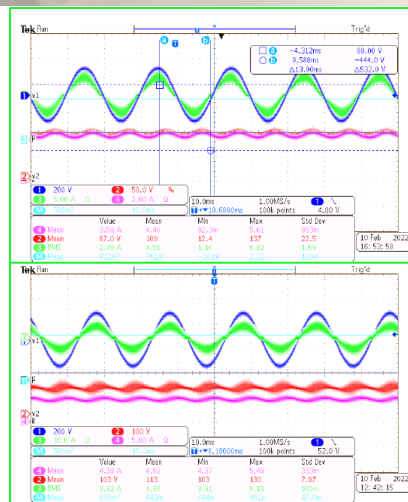
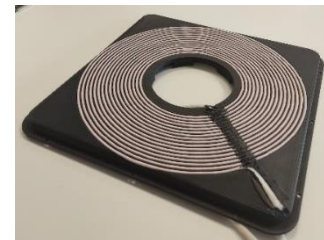
This project has received funding from the European Union's Horizon 2020 research and innovation programme under grant agreement No 826392.

GaN



ECSEL/H2020 (2018-2022)

- Bidirectional domestic 3,6kW Wireless charger
- Low profile design: wallbox and coils in a unique housing.
- Increase the power density using a novel topology).
- 3,6 kW bidirectional charger experimentally validated.
 - Charging distance 100 mm.
 - Switching frequency 85 kHz based on J2954.
 - >96 % efficiency in back-to-back operation.



www.ultimategan.eu

SiC

2013

Boost PFC 2,5 kW



2015

3,2 kW Full-SiC
Contactless battery
charger



2016

Driver SiC 1700 V



DCDC 225kW traction converter
(1,7 kV SiC-hybrid))



2014

SiC 1700 V Driver Core



50 kVA Full-SiC inverter



100 kW battery charger



2017

225 kW DC/DC traction
converter (1,7 kV Full-SiC)



600 kW traction inverter
(3,3 kV SiC-hybrid)



Experiences developed at IKERLAN

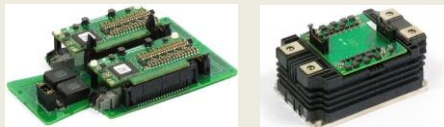
SiC

2018 SiC-hybrid Installation in Euskotren



2019

Study of commercial drivers for SiC (PI, Amantys, Isahaya)



2020 PV SiC 120 kW inverter (1,2k V Full-SiC)



2021 Full-SiC Installation in Euskotren



2018
Photovoltaic SiC inverter
167 kVA (1,2 kV full-SiC)

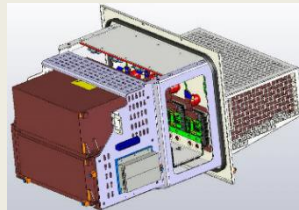


2018
Induction kitchen
7 kW (1,2 kV Full-SiC)



2019

Traction inverter core (3,3 kV full-SiC)



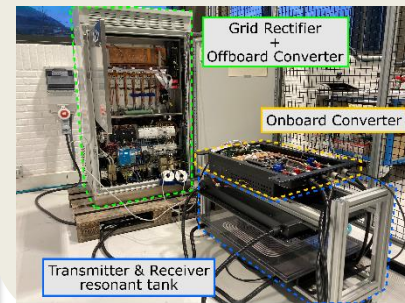
2020

Laboratory tests traction unit
600 kW (3,3kV-Full SiC)



2021

Bidirectional wireless charger
50 kW (1,2kV-Full SiC)



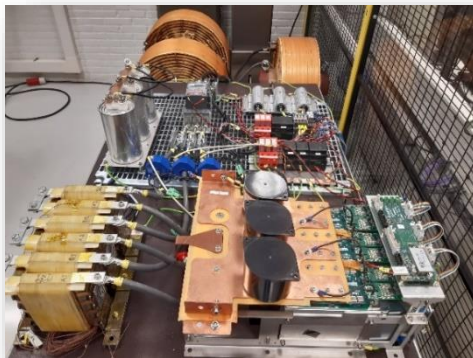
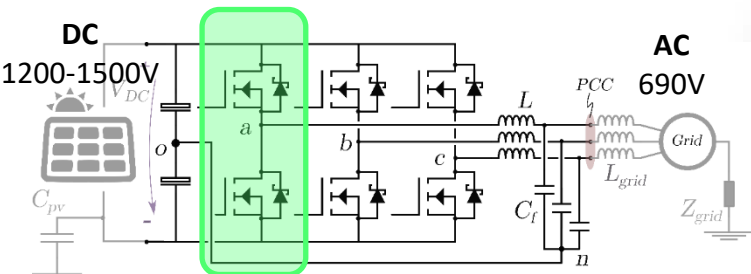
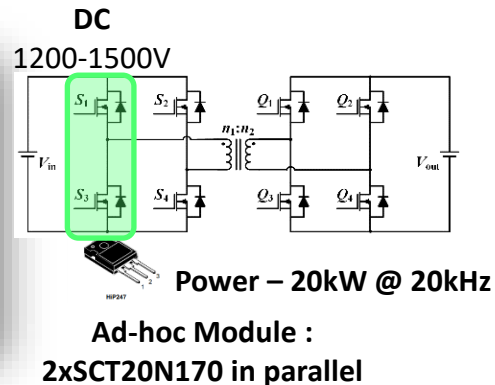
SiC

ECSEL/H2020(2018-2023)

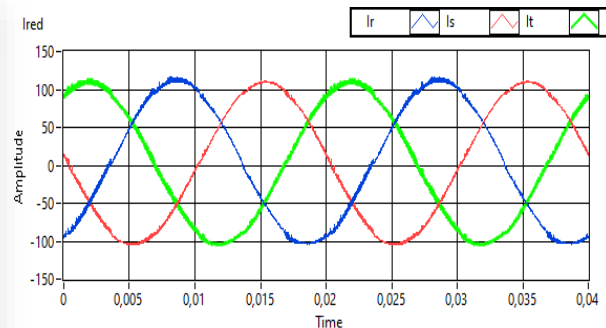
- euRoPEAn siC (Silicon Carbide) eight *T* Inches pilot line
- 1500 Vdc-690Vac 3 phase 2-level SiC Inverter.
 - Up to 100kW.
 - Switching frequency 20 kHz.
 - 98% target efficiency.
 - Experimentally validated
- 20 kW isolated DC/DC charger in design phase.



This project has received funding from the European Union's Horizon 2020 research and innovation programme under grant agreement No 783158.



www.reaction-ecsel.eu



SiC

Shift2Rail (2021-2024)

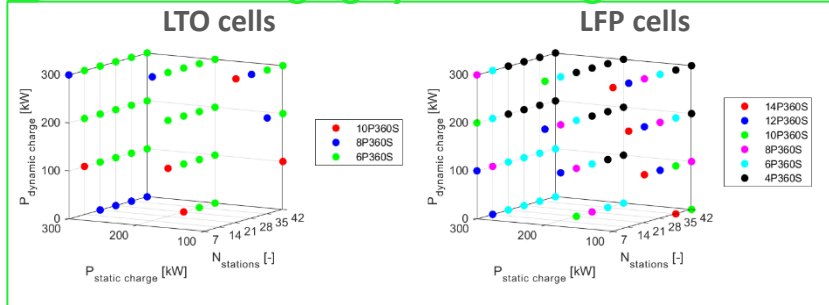


- Dynamic Inductive Power Transfer in railway based on SiC power semiconductors.
- Trade-off study of D-IPT and onboard ESU:
 - Comparison of battery technologies.
 - Comparison of charging systems.
- Impact of SiC devices in D-IPT:
 - Characterization of 1200, 1700 and 3300 V SiC power modules in Zero Voltage Switching (ZVS).
- Ongoing: sizing of SiC-based D-IPT system.
 - Higher efficiency
 - Lower size

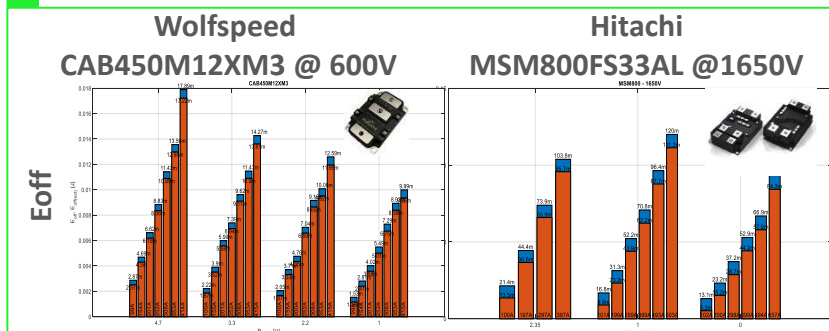


This project has received funding from the European Union's Horizon 2020 research and innovation programme under grant agreement No 101015423.

ESU and charging system sizing results



Estimation of Real-Eoff

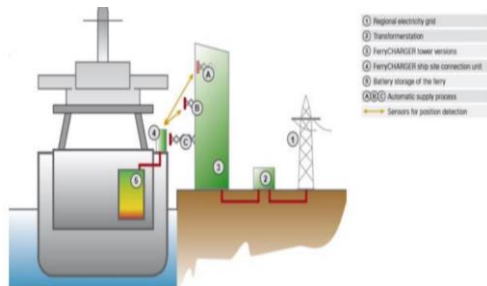


SiC

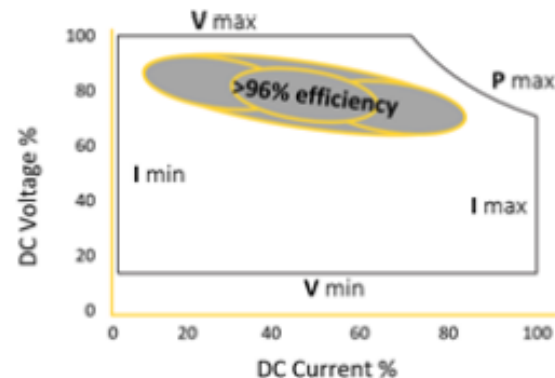
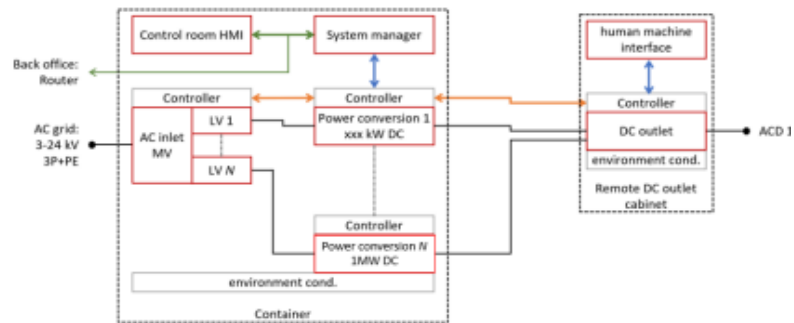
HORIZON EUROPE (2022-2025)

- Fast modular multi-MW charger for maritime application
- Objectives:
 - Improve efficiency by 20%
 - 50% compact charger
 - Reduce charging losses by 50%
 - Reducing operation and maintenance cost by 20%
- Analysis of SiC semiconductors for the charger.
- 2 Prototypes tested for Q2-2025.

HYPOBATT



This project has received funding from the European Union's Horizon 2020 research and innovation programme under grant agreement No 101056853.



SiC – EXPERIENCE IN RAILWAY TRACTION

ikerlan

CAF
Power &
Automation

euskotren



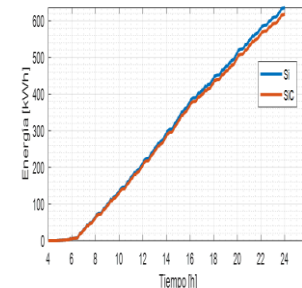
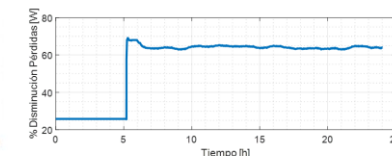
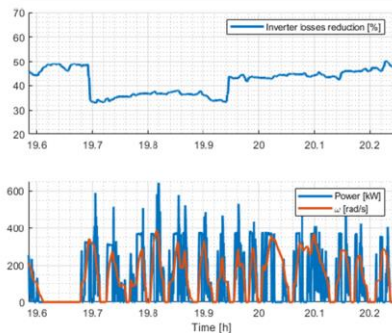
EMU-952 from EUSKOTREN

SiC-hybrid solution

- 600kW inverter
- 3,3kV semiconductors
- Heat-pipe based cooling

INSTALLATION IN OPERATION

Installation date	September 2018
Replacement	A single converter per train
Losses reduction	35 % - 50 %
Energy saving	1,4 % - 3 %



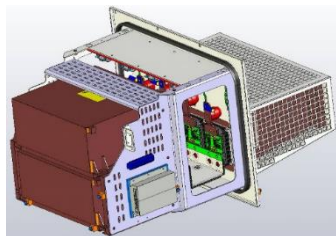
SiC – EXPERIENCE IN RAILWAY TRACTION

ikerlan



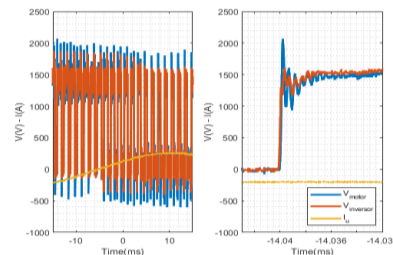
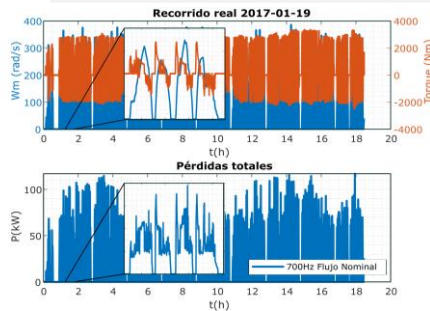
Full-SiC solution

- 600kW inverter
- 3,3kV semiconductors
- Heat-pipe based cooling



INSTALLATION IN OPERATION

Installation date	Q2 2021
Volume reduction	-40 %
Weight reduction	-25 %
Losses reduction	65 %
Cost	+220 % (@2020)





04. Conclusions

- **Every WBG semiconductor has its optimal scope of work**

- GaN -> for low voltages and power, smooth switching and high frequency (>100 kHz)
- SiC -> for high voltages and hard switching (<200 kHz)

- **WBG technology allows to raise switching frequencies well above what silicon allows**

- Minimizes the volume and weight of passive components considerably.
- Minimizes losses significantly in converters (smaller cooling systems).
- Minimizes acoustic noise to non-audible ranges.
- Improvements need to be evaluated at System level, not only at converter level.

- **High current SiC product range available <1200V (discrete and modules)**

- Starting to produce serial devices, but still the price is high.
- SiC is a promising technology in terms of reliability.
- GaN can still be considered immature for mass production products.
- GaN's manufacturing method promises significant price drop.

- **Research should focus on the impact of rapid switching**

- In the degradation of magnetic components insulation due to high dv/dt .
- On EMI effects and filters to comply with EMC regulations.

THANK YOU VERY MUCH

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WHERE
TECHNOLOGY
IS AN ATTITUDE

ikerlan

MEMBER OF BASQUE RESEARCH
& TECHNOLOGY ALLIANCE
